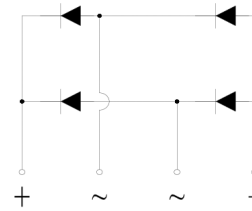
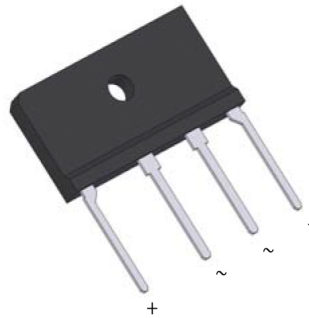


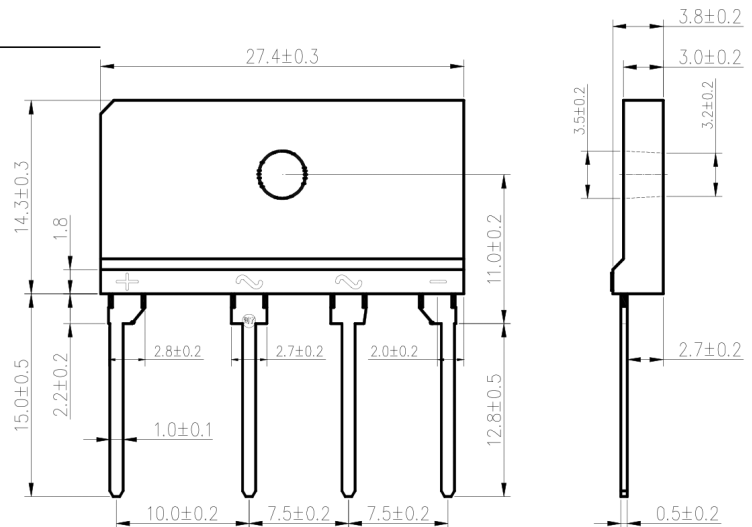
Features

2018

- ◆ Thin Single In-Line package;
- ◆ Ideal for printed circuit boards;
- ◆ Glass Passivated chip junction;
- ◆ Low profile package;
- ◆ High Surge current capability;
- ◆ High case dielectric strength of 2500 V_{RMS};
- ◆ Plastic package has Underwrites Laboratory Flammability Classification 94V-0;
- ◆ Same footprint V.S GBJ package;


**RoHS
COMPLIANT**
Mechanical Data

- ◆ Case: GBJL;
Epoxy meets UL-94V-0 Flammability rating;
- ◆ Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD22-B102;
E3 suffix for customer grade, meet JESD 201;
- ◆ High temperature soldering guaranteed:
Solder Dip 270°C, 10seconds;
- ◆ Polarity: As marked on body;
- ◆ Mounting Torque: 10cm-kg (8.8inches-lbs) max;
- ◆ Recommend Torque: Mounting Torque:
5.7cm-kg (5inches-lbs);


Typical Applications

General purpose use in AC-to-DC bridge full wave rectification for Switching Power Supply, Home Appliances, Office Equipment, Industrial Automation applications.

Package Dimensions in mm

Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbol	GBJL10J	GBJL10K	GBJL10M	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	600	800	1000	V
Maximum RMS voltage	V_{RMS}	420	560	700	V
Maximum DC blocking voltage	V_{DC}	600	800	1000	V
Maximum average forward rectified output current at $T_C=110^\circ\text{C}$ $T_A=25^\circ\text{C}$	$I_{F(AV)}$	10 ⁽¹⁾ 3.0 ⁽²⁾			Amps
Peak forward surge current 8.3 ms single sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	180			Amps
Rating for fusing ($t < 8.3\text{ms}$)	I^2t	135			A ² sec
Maximum Instantaneous forward voltage drop per leg at 5.0A	V_F	0.98			Volt
Maximum DC Reverse Current at Rated DC Blocking Voltage per leg $T_A=25^\circ\text{C}$ $T_A=125^\circ\text{C}$	I_R	5 150			μA
Typical thermal resistance per leg	$R_{\theta JA}$ $R_{\theta JC}$	22 ⁽²⁾ 2.1 ⁽¹⁾			°C/W
Operating junction and Storage Temperature Range	T_J, T_{STG}	-55 to +150			°C

Notes:

- 1). Unit case mounted on Al plate heatsink;
- 2). Units mounted on PCB without heatsink;
- 3). Recommended mounting position is to bolt down on heatsink with silicone thermal compound for maximum heat transfer with #6 screw.

RATINGS AND CHARACTERISTICS CURVES

($T_A=25^{\circ}\text{C}$ unless otherwise noted)

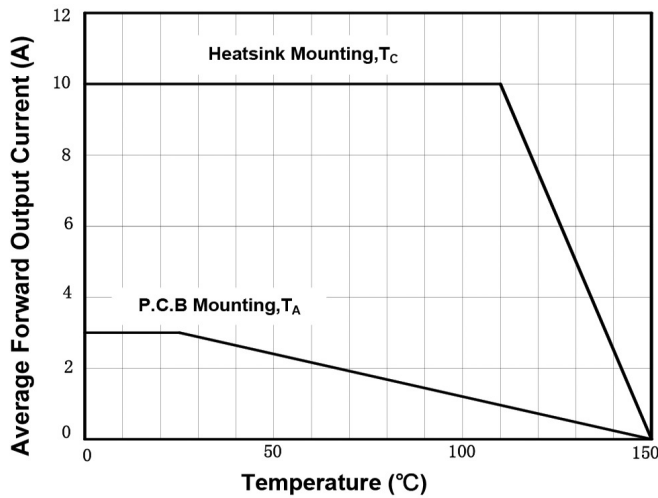


Figure 1. Derating Curve Output Rectified Current

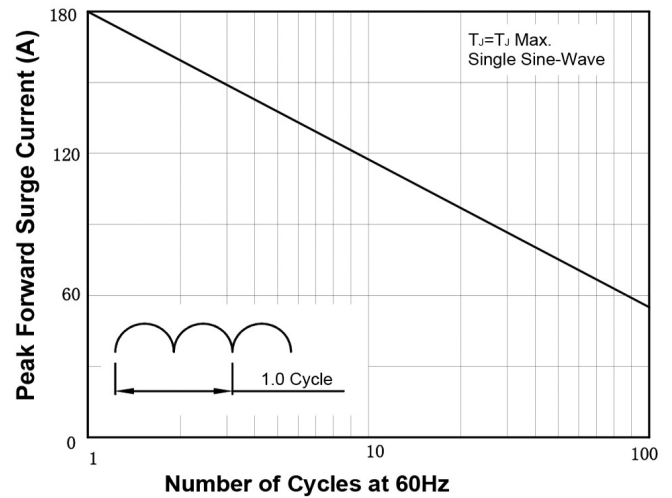


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current per Diode

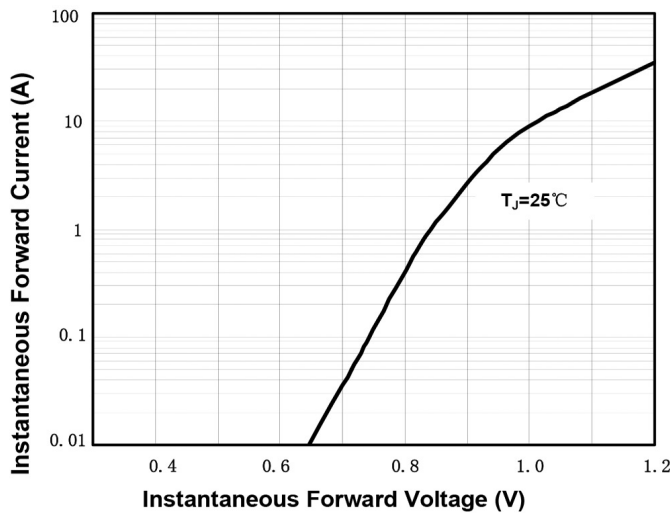


Figure 3. Typical Forward Characteristics Per Diode

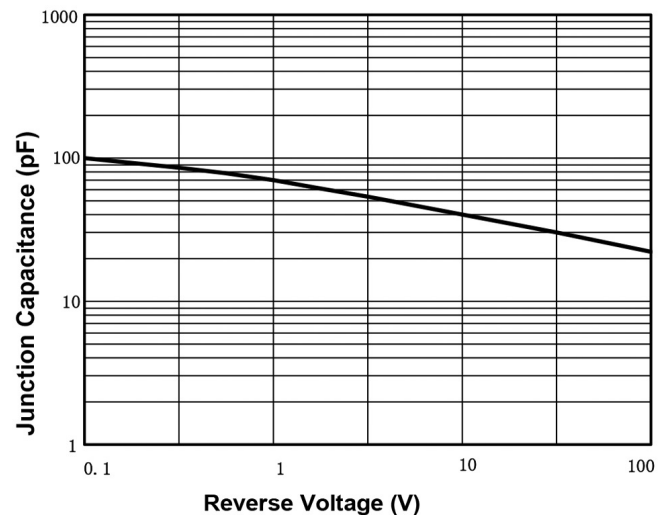


Figure 4. Typical Junction Capacitance Per Diode

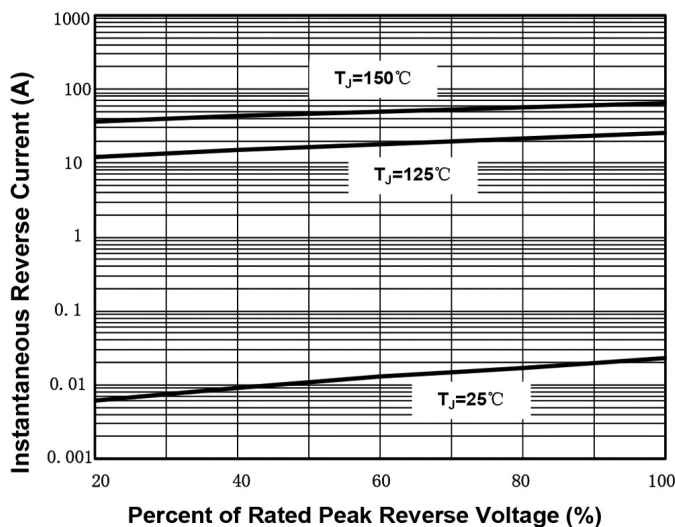


Figure 5. Typical Reverse Characteristics Per Diode